

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

| Characteristic | Symbol | 2N3027 2N3030 | 2N3028 2N3031 | 2N3029 2N3032 |
|--------------------------------------------------------|-------------|------------------|------------------|------------------|
| Repetitive peak off-state voltage | V_{DRM} | 30V | 60V | 100V |
| Repetitive peak reverse voltage | V_{RRM} | 30V | 60V | 100V |
| DC on-state current 100°C case 75°C ambient | I_T | | 500mA 250mA | |
| Repetitive peak on-state current | I_{TRM} | | 30A | |
| Surge (non-repetitive) on-state current 50ms 8ms | I_{TSM} | | 5A 8A | |
| Peak gate current | I_{GM} | | 250mA | |
| Average gate current | $I_{G(AV)}$ | | 25mA | |
| Reverse gate voltage | V_{GR} | | 5V | |
| Reverse gate current | I_{GR} | | 3mA | |
| Storage temperature range | T_{stg} | | -65°C to +200°C | |
| Operating temperature range | T_J | | -65°C to +150°C | |

Blocking voltage ratings apply over the operating temperature range, provided the gate is connected to the cathode through an appropriate resistor, or adequate gate bias is used.

ELECTRICAL CHARACTERISTIC (@ 25°C unless otherwise noted) (2N3027-2N3029)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|-------------------------------------------|--------------|-------|-------|-------|------|-------------------------------------------------|
| 25°C tests | | | | | | |
| Off state current | I_{DRM} | - | 0.002 | 0.100 | μA | $R_{GK} = 1K\Omega$, $V_{DRM} = \text{rating}$ |
| Reverse current | I_{RRM} | - | 0.002 | 0.100 | μA | $R_{GK} = 1K\Omega$, $V_{RRM} = \text{rating}$ |
| Reverse gate voltage | V_{GR} | 5 | 8 | - | V | $I_{GR} = 0.1mA$ |
| Gate trigger current | I_{GT} | -5 | 8 | 200 | μA | $R_{GS} = 10K\Omega$, $V_D = 5V$ |
| Gate trigger voltage | V_{GT} | 0.400 | 0.550 | 0.800 | V | $R_{GS} = 100\Omega$, $V_D = 5V$ |
| On-state voltage | V_T | 0.800 | 1.200 | 1.500 | V | $I_T = 1A$ (pulse test) |
| Holding current | I_H | 0.300 | 0.700 | 5.000 | mA | $R_{GK} = 1K\Omega$, $V_D = 5V$ |
| Off-state voltage – critical rate of rise | dv/dt | 30 | 60 | - | V/μs | $R_{GK} = 1K\Omega$, $V_D = 30V$ (2N3027) |
| | | 15 | 30 | - | | $R_{GK} = 1K\Omega$, $V_D = 60V$ (2N3028) |
| | | 10 | 25 | - | | $R_{GK} = 1K\Omega$, $V_D = 100V$ (2N3029) |
| Gate trigger-on pulse width | $t_{pg(on)}$ | - | 0.070 | 0.200 | μs | $I_G = 10mA$, $I_T = 1A$, $V_D = 30V$ |
| Delay time | t_d | - | 0.080 | - | μs | $I_G = 10mA$, $I_T = 1A$, $V_D = 30V$ |
| Rise time | t_r | - | 0.040 | - | μs | $I_G = 10mA$, $I_T = 1A$, $V_D = 30V$ |
| Circuit commutated turn-off time | t_g | - | 0.700 | 2.000 | μs | $I_T = 1A$, $I_R = 1A$, $R_{GK} = 1K\Omega$ |

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|---------------------------------------|-----------|-------|-------|-------|---------|----------------------------------------------|
| 150°C Tests | | | | | | |
| High temperature off-state current | I_{DRM} | - | 2 | 20 | μA | $R_{GK} = 1K\Omega, V_{DRM} = \text{rating}$ |
| High temperature reverse current | I_{RRM} | - | 20 | 50 | μA | $R_{GK} = 1K\Omega, V_{RRM} = \text{rating}$ |
| High temperature gate trigger voltage | V_{GT} | 0.100 | 0.150 | 0.600 | V | $R_{GS} = 100\Omega, V_D = 5V$ |
| High temperature holding current | I_H | 0.050 | 0.200 | 1.000 | mA | $R_{GK} = 1K\Omega, V_D = 5V$ |
| -65°C Tests | | | | | | |
| Low temperature gate trigger voltage | V_{GT} | 0.600 | 0.750 | 1.100 | V | $R_{GS} = 100\Omega, V_D = 5V$ |
| Low temperature gate trigger current | I_{GT} | 0 | 150 | 1.200 | mA | $R_{GS} = 10K\Omega, V_D = 5V$ |
| Low temperature holding current | I_H | 0.500 | 3.500 | 10 | mA | $R_{GK} = 1K\Omega, V_D = 5V$ |

ELECTRICAL CHARACTERISTIC (@ 25°C unless otherwise noted) (2N3030-2N3032)

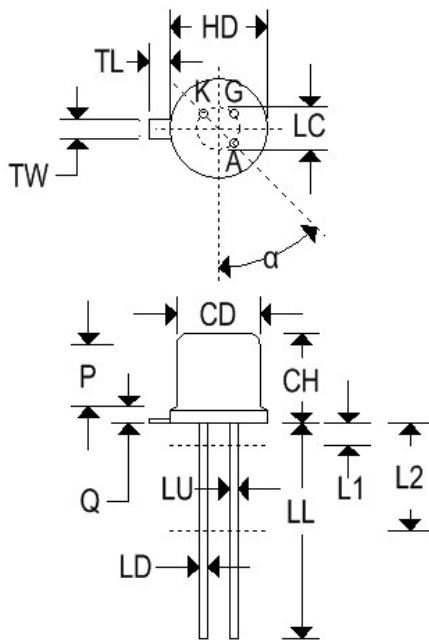
| | | | | | | |
|-------------------------------------------|--------------|-------|-------|-------|------------|----------------------------------------------|
| 25°C tests | | | | | | |
| Off state current | I_{DRM} | - | 0.002 | 0.100 | μA | $R_{GK} = 1K\Omega, V_{DRM} = \text{rating}$ |
| Reverse current | I_{RRM} | - | 0.002 | 0.100 | μA | $R_{GK} = 1K\Omega, V_{RRM} = \text{rating}$ |
| Reverse gate voltage | V_{GR} | 5 | 8 | - | V | $I_{GR} = 0.1mA$ |
| Gate trigger current | I_{GT} | -5 | | 20 | μA | $R_{GS} = 10K\Omega, V_D = 5V$ |
| Gate trigger voltage | V_{GT} | 0.440 | | 0.600 | V | $R_{GS} = 100\Omega, V_D = 5V$ |
| On-state voltage | V_T | 0.800 | 1.200 | 1.500 | V | $I_T = 1A$ (pulse test) |
| Holding current | I_H | 0.300 | 1.000 | 4.000 | mA | $R_{GK} = 1K\Omega, V_D = 5V$ |
| Off-state voltage – critical rate of rise | dv/dt | 30 | 60 | - | V/ μs | $R_{GK} = 1K\Omega, V_D = 30V$ (2N3030) |
| | | 15 | 30 | - | | $R_{GK} = 1K\Omega, V_D = 60V$ (2N3031) |
| | | 10 | 25 | - | | $R_{GK} = 1K\Omega, V_D = 100V$ (2N3032) |
| Gate trigger-on pulse width | $t_{pg(on)}$ | - | 0.050 | 0.100 | μs | $I_G = 10mA, I_T = 1A, V_D = 30V$ |
| Delay time | t_d | - | 0.100 | - | μs | $I_G = 10mA, I_T = 1A, V_D = 30V$ |
| Rise time | t_r | - | 0.050 | - | μs | $I_G = 10mA, I_T = 1A, V_D = 30V$ |
| Circuit commutated turn-off time | t_g | - | 0.700 | 2.000 | μs | $I_T = 1A, I_R = 1A, R_{GK} = 1K$ |
| 150°C Tests | | | | | | |
| High temperature off-state current | I_{DRM} | - | 2 | 20 | μA | $R_{GK} = 1K\Omega, V_{DRM} = \text{rating}$ |
| High temperature reverse current | I_{RRM} | - | 20 | 50 | μA | $R_{GK} = 1K\Omega, V_{RRM} = \text{rating}$ |
| High temperature gate trigger voltage | V_{GT} | 0.100 | 0.150 | 0.400 | V | $R_{GS} = 100\Omega, V_D = 5V$ |
| High temperature holding current | I_H | 0.050 | 0.300 | 2.000 | mA | $R_{GK} = 1K, V_D = 5V$ |
| -65°C Tests | | | | | | |
| Low temperature gate trigger voltage | V_{GT} | 0.440 | 0.800 | 0.950 | V | $R_{GS} = 100\Omega, V_D = 5V$ |
| Low temperature gate trigger current | I_{GT} | 0 | 0.400 | 0.500 | mA | $R_{GS} = 10K\Omega, V_D = 5V$ |
| Low temperature holding current | I_H | 0.500 | 5.000 | 8 | mA | $R_{GK} = 1K\Omega, V_D = 5V$ |

2N3027-2N3032

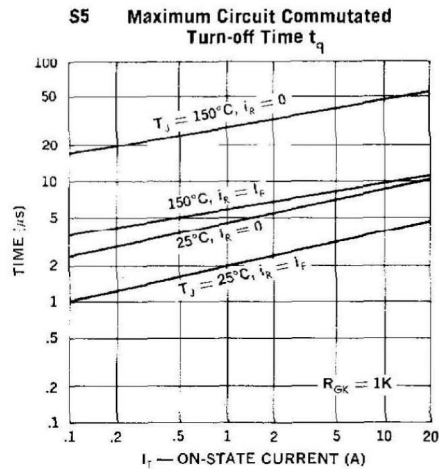
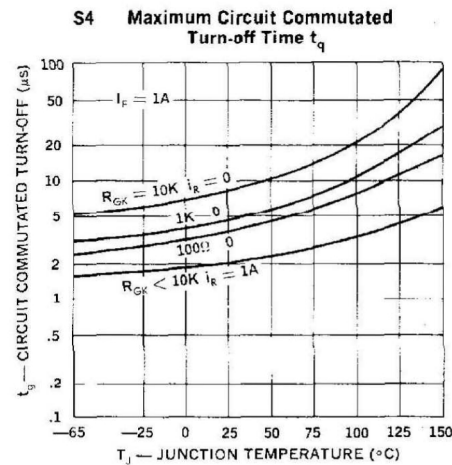
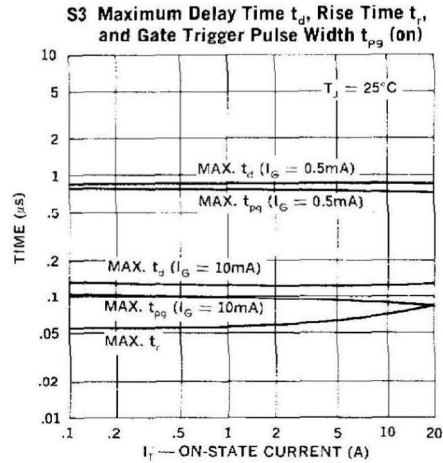
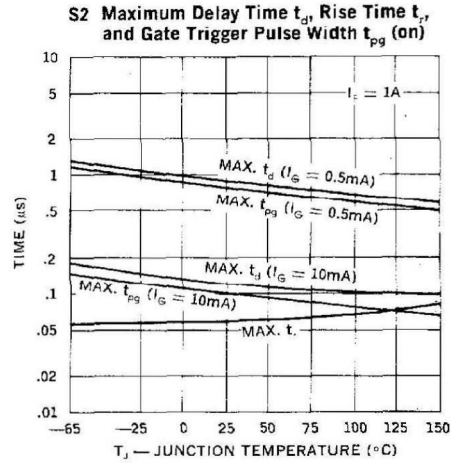
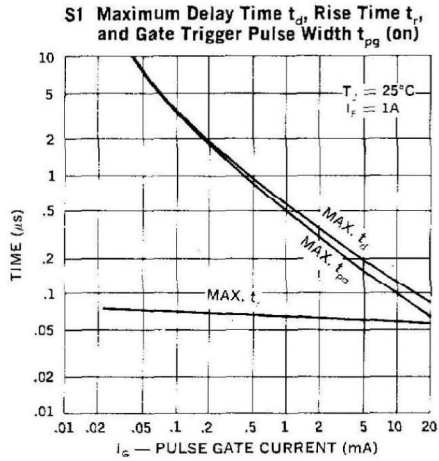
SILICON CONTROLLED RECTIFIER

MECHANICAL CHARACTERISTICS

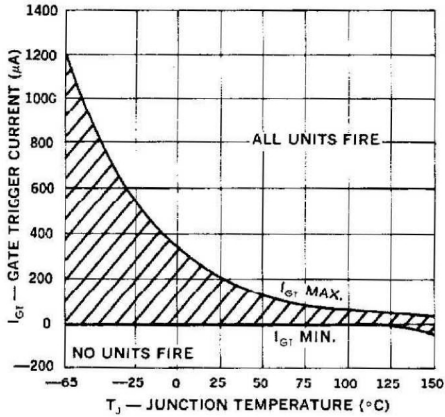
| | |
|---------|---------------|
| Case | TO-18 |
| Marking | Alpha-numeric |
| Pin out | See below |



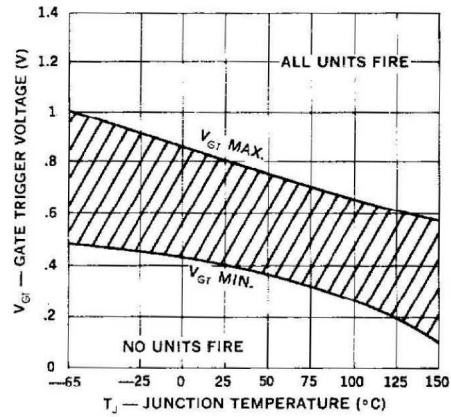
| | TO-18 | | | |
|---|-----------|-------|-------------|-------|
| | Inches | | Millimeters | |
| | Min | Max | Min | Max |
| A | 0.209 | 0.230 | 5.310 | 5.840 |
| B | 0.178 | 0.195 | 4.520 | 4.950 |
| C | 0.170 | 0.210 | 4.320 | 5.330 |
| D | 0.016 | 0.021 | 0.406 | 0.533 |
| E | - | 0.030 | - | 0.762 |
| F | 0.016 | 0.019 | 0.406 | 0.483 |
| G | 0.100 BSC | | 2.540 BSC | |
| H | 0.036 | 0.046 | 0.914 | 1.170 |
| J | 0.028 | 0.048 | 0.711 | 1.220 |
| K | 0.500 | - | 12.700 | - |
| L | 0.250 | - | 6.350 | - |
| M | 45° BSC | | 45° BSC | |
| N | 0.050 BSC | | 1.270 BSC | |
| P | - | 0.050 | - | 1.270 |



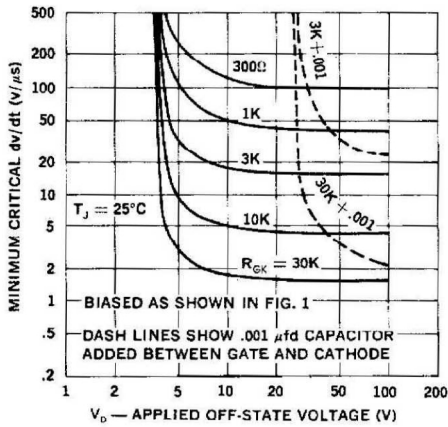
1 Gate Trigger Current



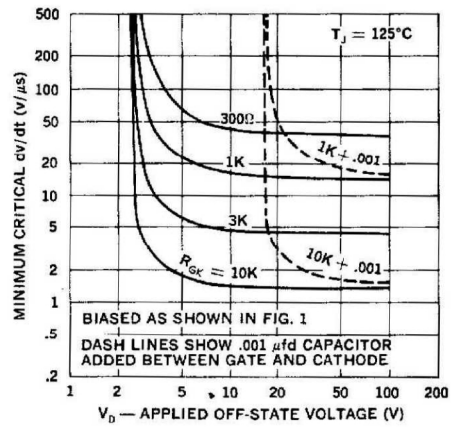
2 Gate Trigger Voltage



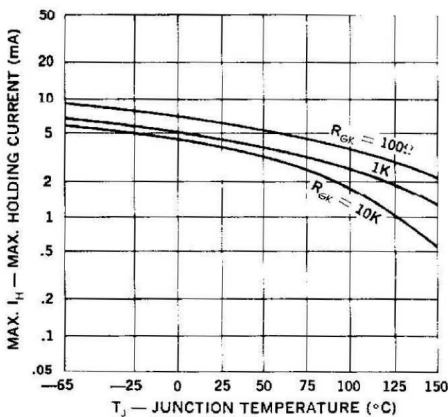
3 Min. Critical dv/dt (25°C — R Bias)



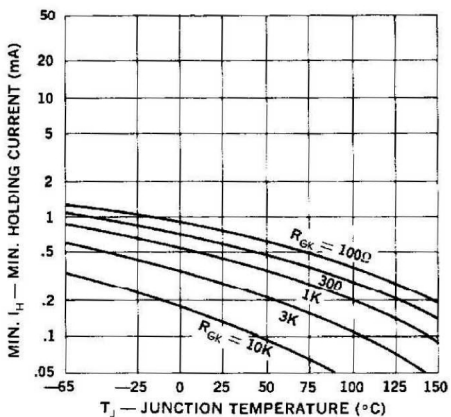
4 Min. Critical dv/dt (125°C — R Bias)



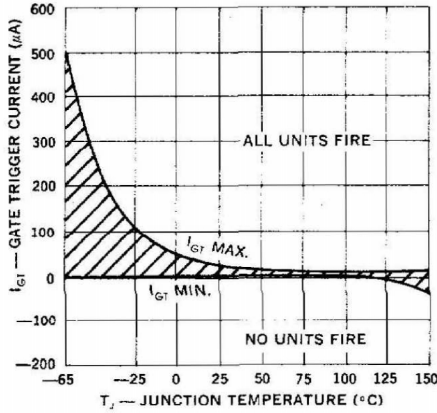
5 Max. Holding Current (Resistor Bias)



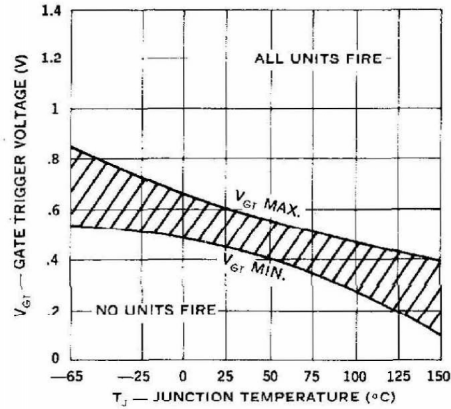
6 Min. Holding Current (Resistor Bias)



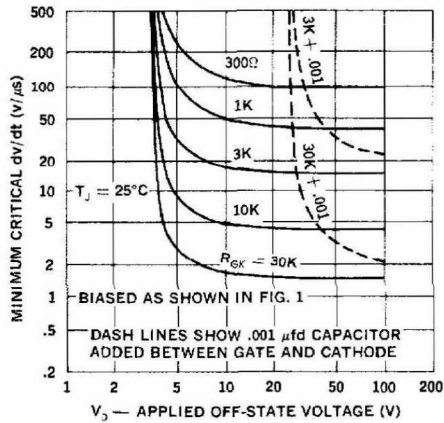
1 Gate Trigger Current



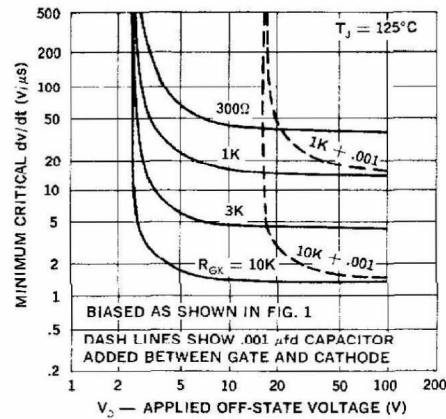
2 Gate Trigger Voltage



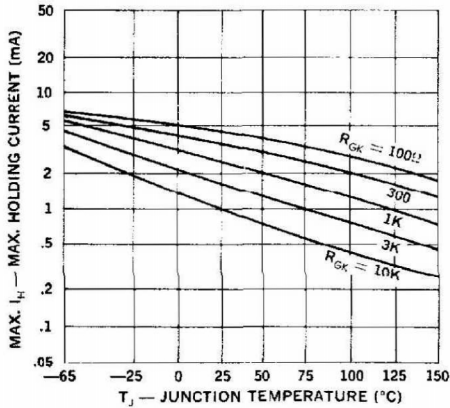
3 Min. Critical dv/dt (25°C — R Bias)



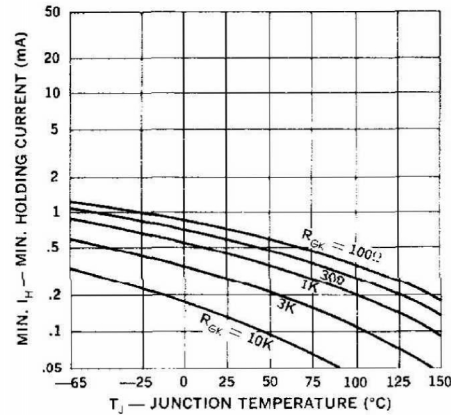
4 Min. Critical dv/dt (125°C — R Bias)



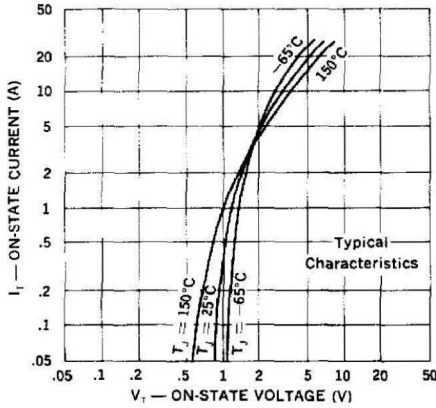
5 Max. Holding Current (Resistor Bias)



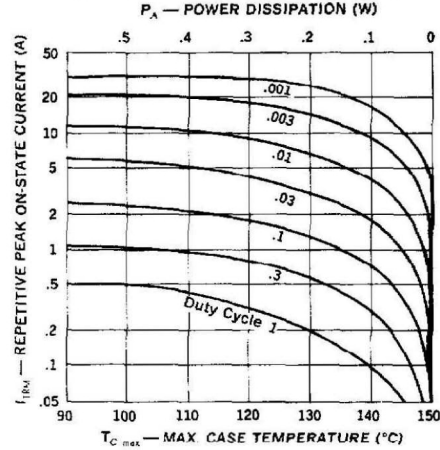
6 Min. Holding Current (Resistor Bias)



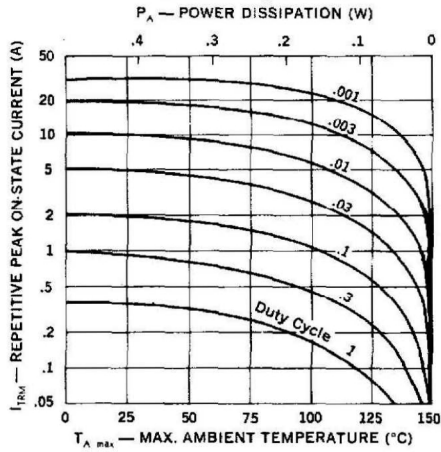
C1 Forward on Current vs. Voltage



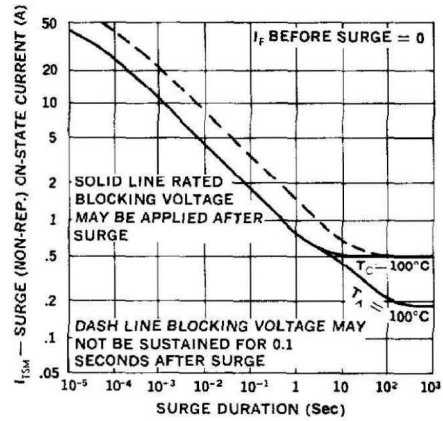
C2 Peak Current vs. Case Temperature



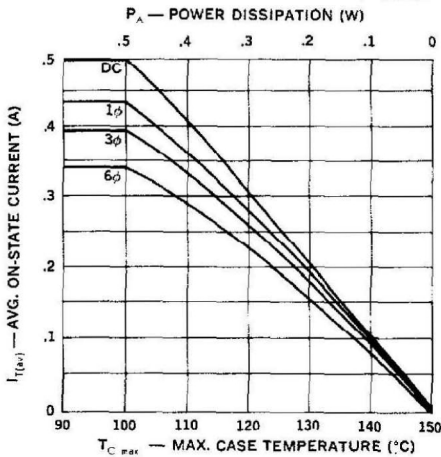
C3 Peak Current vs. Ambient Temperature
TO-18 Ratings (see note)



C4 Surge Current vs. Time



C5 Average Current vs. Case Temperature



C6 Average Current vs. Ambient Temperature
TO-18 Ratings (see note)

